

## YDS-N6MF-IMX274 V1.0

### 8.3MP Sony IMX274 MIPI Interface M12 Fixed Focus Camera Module



Front View



Back View

#### Specifications

|                          |                                       |
|--------------------------|---------------------------------------|
| Camera Module No.        | YDS-N6MF-IMX274 V1.0                  |
| Resolution               | 8.3MP                                 |
| Image Sensor             | IMX274                                |
| Sensor Type              | 1/2.5"                                |
| Pixel Size               | 1.62 um x 1.62 um                     |
| EFL                      | 3.60 mm                               |
| F.NO                     | 2.00                                  |
| Pixel                    | 3840 x 2160                           |
| View Angle               | 130.0°(DFOV) 100.0°(HFOV) 59.0°(VFOV) |
| Lens Dimensions          | 13.65 x 13.65 x 22.52 mm              |
| Module Size              | 40.00 x 22.00 mm                      |
| Module Type              | Fixed Focus                           |
| Interface                | MIPI                                  |
| Auto Focus VCM Driver IC | None                                  |
| Lens Model               | YDS-LENS-MJ3621A                      |
| Lens Type                | 650nm IR Cut                          |
| Operating Temperature    | -30°C to +75°C                        |
| Mating Connector         | DF30FC-30DS-0.4V                      |



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### 8.3MP Sony IMX274 MIPI Interface M12 Fixed Focus Camera Module



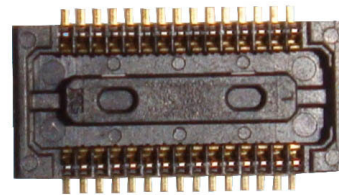
Top View



Side View

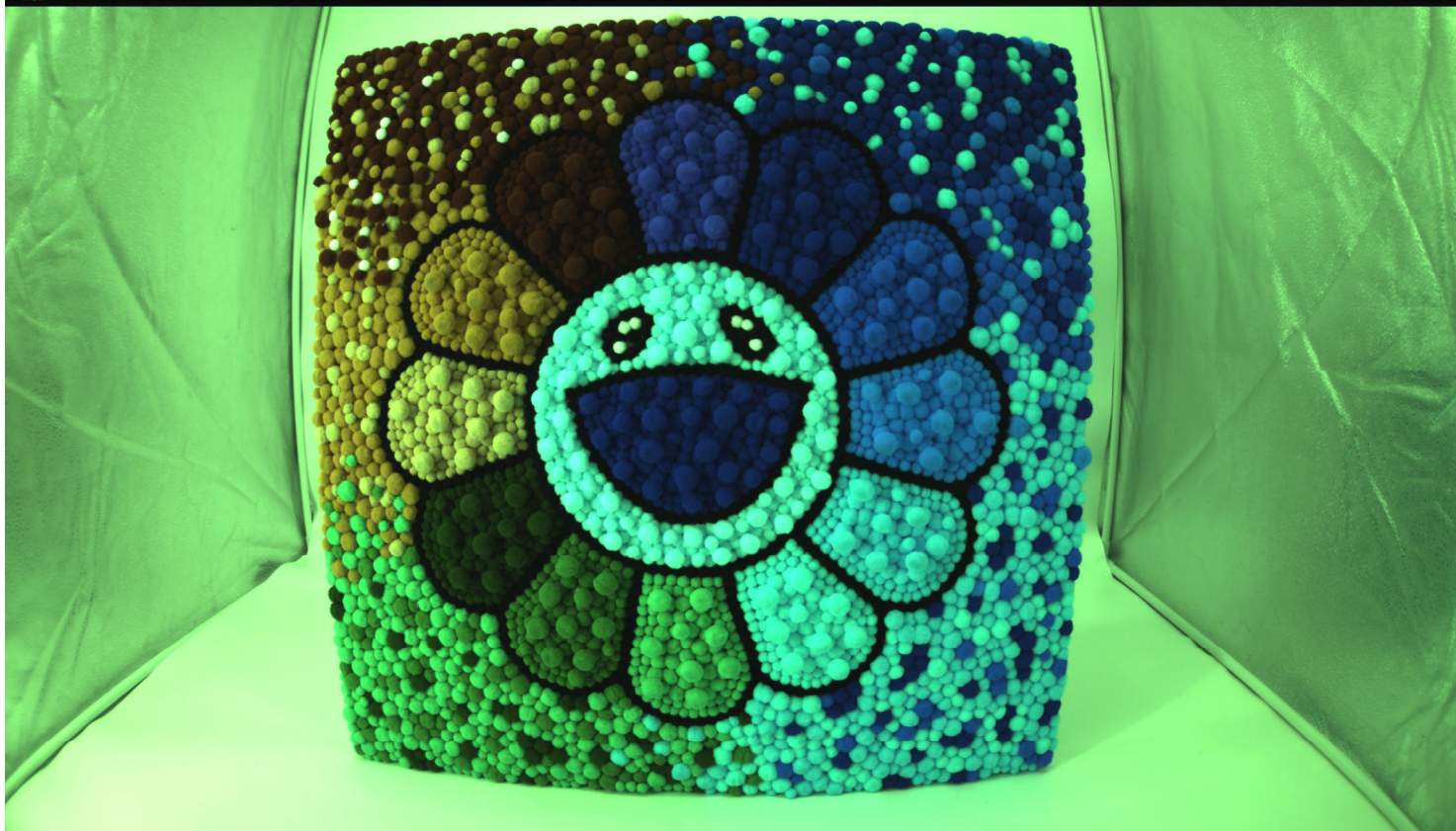
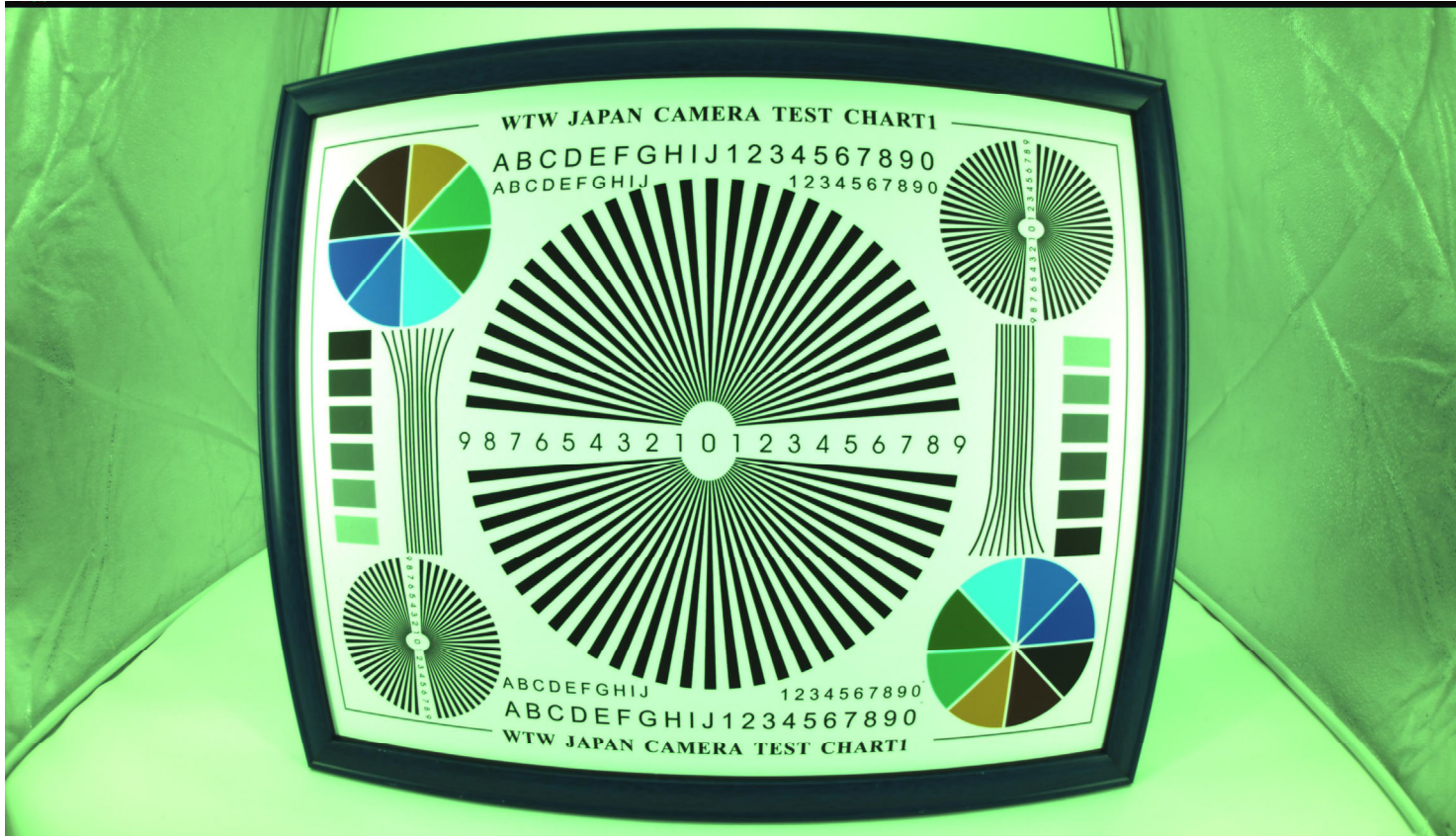


Bottom View

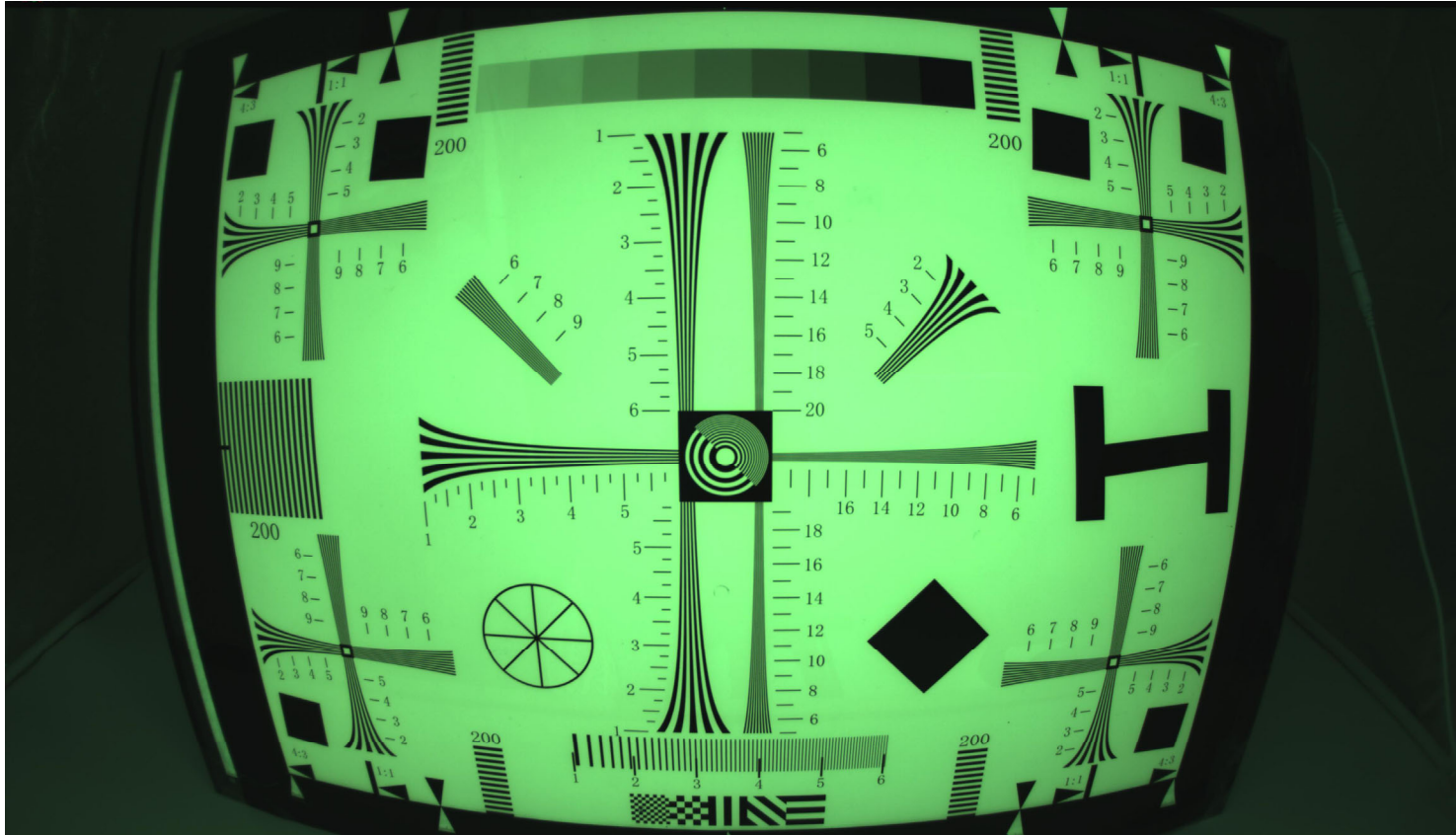


Mating Connector

**Real Test Images**  
**N6MF-IMX274 V1.0**

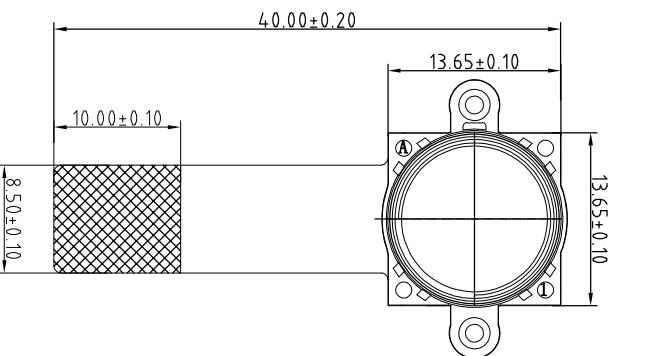


Real Test Images  
N6MF-IMX274 V1.0

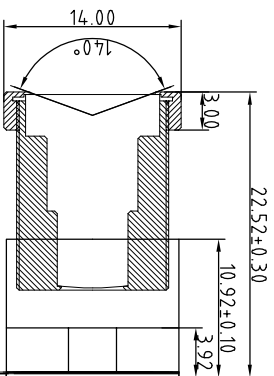


| Version Mark | Information      | Date       |
|--------------|------------------|------------|
| V1.0         | PD First Version | 04-09-2019 |

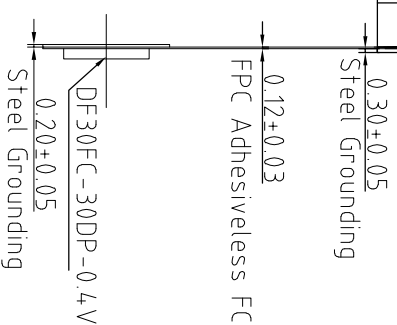
| RoHS |           |
|------|-----------|
| PIN  | SIGNAL    |
| 1    | XCE       |
| 2    | DGND      |
| 3    | DVDD1.2V  |
| 4    | DOVDD1.8V |
| 5    | XHS       |
| 6    | XVS       |
| 7    | AVDD2.8V  |
| 8    | AGND      |
| 9    | SDA       |
| 10   | SCL       |
| 11   | DGND      |
| 12   | XCLR      |
| 13   | DGND      |
| 14   | INCK      |
| 15   | DGND      |
| 16   | DMO4P     |
| 17   | DMO4N     |
| 18   | DGND      |
| 19   | DMO3P     |
| 20   | DMO3N     |
| 21   | DGND      |
| 22   | DMO2P     |
| 23   | DMO2N     |
| 24   | DGND      |
| 25   | DMCKP     |
| 26   | DMCKN     |
| 27   | DGND      |
| 28   | DMO1P     |
| 29   | DMO1N     |
| 30   | DGND      |



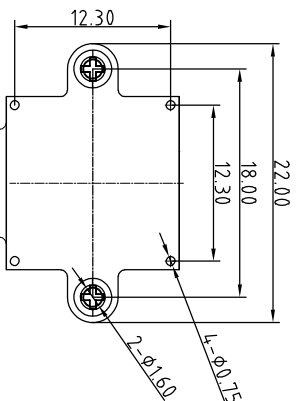
TOP VIEW



SIDE VIEW



BOTTOM VIEW



Parameters:

1、Sensor specification:

Image Sensor: IMX274LAC-C  
 Pixel: 1.62umx1.62um  
 Lens Type: 1/2.5  
 Important Voltage Description: DVDD1.2V  
 (external power supply);

2、Lens specification:

FOV: 140°  
 F/NO: 2.0  
 TV distortion: <25%  
 Focal length: 3.6mm  
 Composition: 4G +IRFILTER  
 IR Cut Coating: 650nm±10nm@50%

Designed By

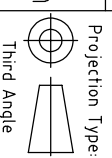
Kevin

Model Name:

N6MF-IMX274 V1.0

Checked By

Aouly Yan



Unit: mm

Scale: 1:1

Material: -----  
 Sheet: 1 of 1

Version: 1/0

A

B

C

D

E

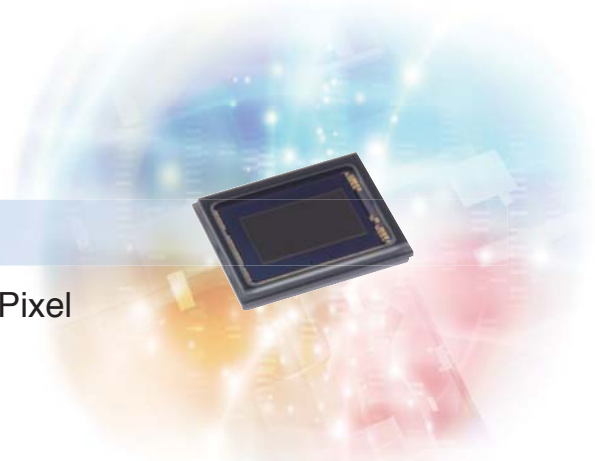
3

2

1

## IMX274LQC

Diagonal 7.20 mm (Type 1/2.5) Approx. 8.51M-Effective Pixel  
Color CMOS Image Sensor



### 16:9 Aspect Ratio CMOS Image Sensor Capable of 4K (3840 × 2160) Output for Industrial Applications

Sony has commercialized the "IMX274LQC" Type 1/2.5 (16:9) back-illuminated CMOS image sensor with approximately 8.51M effective pixels for the expanding 4K market.

The IMX274LQC is capable of 4K (3840 × 2160) output at 60 frames/s in ADC 10-bit mode. In addition, the DOL (Digital Overlap)-type HDR (High Dynamic Range) function is

supported at 30 frames/s, realizing 4K video imaging with a wide dynamic range. The IMX274LQC has lower power consumption and is smaller than the existing 4K support CMOS image sensor (IMX172LQT), and the interface supports Sub-LVDS and MIPI CSI-2, enabling use in security camera and industrial applications.

- High-speed video imaging function
- Versatile interface
- DOL-HDR function
- Compact device size

#### Exmor R

\*Exmor R is a trademark of Sony Corporation. The Exmor R is a Sony's CMOS image sensor with significantly enhanced imaging characteristics including sensitivity and low noise by changing fundamental structure of Exmor™ pixel adopted column parallel A/D converter to back-illuminated type.

#### STARVIS

\*STARVIS is a trademark of Sony Corporation. The STARVIS is back-illuminated pixel technology for CMOS image sensors for surveillance camera applications. It features a sensitivity of 2000 mV or more per 1 μm<sup>2</sup> (color product, when imaging with a 706 cd/m<sup>2</sup> light source, F5.6 in 1 s accumulation equivalent), and realizes high picture quality in the visible-light and near infrared light regions.

### High-speed video imaging function

The IMX274LQC realizes 4K (3840 × 2160) all-pixel scan at 30 frames/s in ADC 12-bit mode, and at the high frame rate output of 60 frames/s in ADC 10-bit mode, making it the ideal CMOS image sensor for expanding 4K market applications. The IMX274LQC also realizes Full HD (1920 × 1080) output at 60 frames/s in ADC 12-bit mode (mode 1) and 120 frames/s

in ADC 10-bit mode (mode 2), enabling high-speed video imaging. In addition, various other readout methods are also supported, and diverse drive modes can be selected (Table-3).

Use of a lower frame rate makes it possible to reduce power consumption.

### Versatile interface

The IMX274LQC is equipped with two types of output interface (Sub-LVDS, MIPI CSI-2) to meet diverse needs. Both interfaces are capable of 4K 60 frames/s (ADC 10-bit) output, so the

interface can be selected in accordance with the DSP and system used (Table-1).

### DOL-HDR function

The IMX274LQC is Sony's first CMOS image sensor to support a DOL-type HDR function for a 4K angle of view. This makes it possible to shoot 4K video with an expanded dynamic

range. The modes that support the DOL function are 4K (3840 × 2160) ADC 10-bit 30 frames/s and Full HD (1920 × 1080) ADC 10-bit 60 frames/s (Table-3).

### Compact device size

The IMX274LQC realizes a compact package size of 10.70 mm (H) × 8.50 mm (V) × 1.62 mm (t). This reduced camera

size expands the range of potential security camera and industrial applications.

<Table 1> Device Structure

| Item                                  |            | IMX274LQC   |
|---------------------------------------|------------|---|
| Output image size                     |            | Diagonal 7.20 mm (Type 1 / 2.5) aspect ratio 16:9   |
| Number of effective pixels            |            | 3864 (H) × 2202 (V) approx. 8.51M pixels  |
| Unit cell size                        |            | 1.62 μm (H) × 1.62 μm (V)   |
| Optical blacks                        | Horizontal | Front: 0 pixels, rear: 0 pixels   |
|                                       | Vertical   | Front: 16 pixels, rear: 0 pixels  |
| Input drive frequency                 |            | 12 MHz / 24 MHz / 36 MHz / 72 MHz (Sub-LVDS)<br>6 MHz / 12 MHz / 18 MHz / 24 MHz (MIPI CSI-2) |
| Interface                             |            | Sub-LVDS (576 Mbps / ch, Max.10 ch) *1<br>MIPI CSI-2 (1.440 Gbps / Lane) *1                   |
| Package                               |            | 92-pin LGA  |
| Supply voltage V <sub>DD</sub> (Typ.) |            | 2.8 V / 1.8 V / 1.2 V   |

\*1 Sensor slave mode when using Sub-LVDS and sensor master mode when using MIPI.

<Table 2> Image Sensor Characteristics

| Item               |      | Value  | Remarks                |
|--------------------|------|--------|------------------------|
| Sensitivity (F5.6) | Typ. | 237 mV | 1/30s accumulation     |
| Saturation signal  | Min. | 630 mV | T <sub>j</sub> = 60 °C |

<Table 3> Basic Drive Mode

| Drive mode              | Recommended number of recording pixels | Frame rate [frame/s] | ADC[bit] |
|-------------------------|--|----------------------|----------|
| All-pixel scan (12 bit) | 3840 (H) × 2160 (V)                    | 29.97                | 12       |
| All-pixel scan (10 bit) | 3840 (H) × 2160 (V)                    | 59.94                | 10       |
| Mode 1*2 (12 bit)       | 1920 (H) × 1080 (V)                    | 59.94                | 12       |
| Mode 2*2 (10 bit)       | 1920 (H) × 1080 (V)                    | 119.88               | 10       |
| Mode 3*2 (10 bit)       | 1920 (H) × 1080 (V)                    | 29.97                | 10       |
| Mode 4*2                | 1280 (H) × 720 (V)                     | 119.88               | 10       |
| Mode 5*2                | 1280 (H) × 540 (V)                     | 239.76               | 10       |

| Drive mode                     | Recommended number of recording pixels | Frame rate [frame/s] | ADC[bit] |
|--------------------------------|--|----------------------|----------|
| All-pixel scan (10 bit) DOL *1 | 3840 (H) × 2160 (V)                    | 29.97                | 10       |
| Mode 6 (10 bit) DOL *1*2       | 1920 (H) × 1080 (V)                    | 59.94                | 10       |

\*1 There are restrictions on the storage time setting values when using DOL.

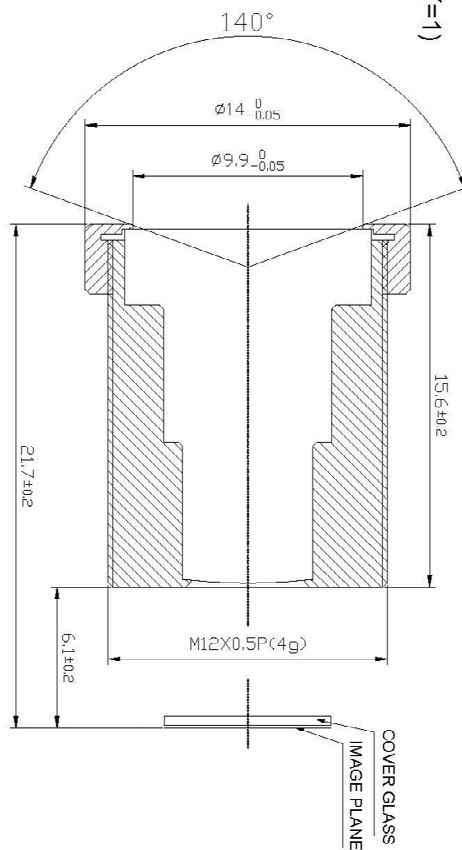
\*2 With vertical addition

\*Sony reserves the right to change products and specifications without prior notice.

## YDS-LENS-MJ3621A

### SPECIFICATION

1. FOR 1/2.5" SENSOR
2. IMAGE HEIGHT  $\phi 7.3$
3. EFL=3.6mm
4. WORKING F/NO.=2.0
5. BFL=5.5mm
6. FOV=140°
7. TV DISTORTION=2.5%
8. RELATIVE ILLUMINATION=65%( $\gamma=1$ )
9. CONSTRUCTION: 4G
10. THREAD : M12X0.5P



|   |                  |            |            |            |             |                |            |               |            |
|---|------------------|------------|------------|------------|-------------|----------------|------------|---------------|------------|
| ① | 修改记录<br>REVISION | 姓名<br>NAME | 日期<br>DATE | 单位<br>UNIT | 比例<br>SCALE | 材料<br>MATERIAL | 批次<br>REV. | 审核<br>CHECKED | 日期<br>DATE |
| ② |                  |            |            |            | 1:2.1       |                | A-01       |               |            |
| ③ |                  |            |            |            |             |                |            |               |            |
| ④ |                  |            |            |            |             |                |            |               |            |
| ⑤ |                  |            |            |            |             |                |            |               |            |

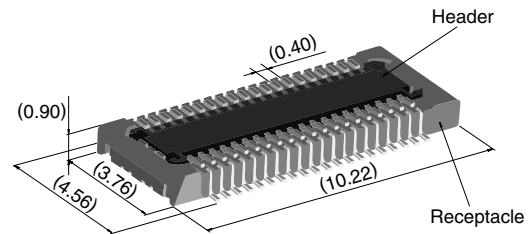


# 0.4 mm Pitch, 0.9 mm Height, Board-to-Board / Board-to-FPC Connectors

## DF30 Series



### Extremely small size



40 positions shown

### Overview

Continuous miniaturization and increased component density on PCB created demand for extremely low profile connectors. This series is addition of a new extremely low profile connectors to Hirose's wide range of high reliability board-to-board/board-to-FPC connection solutions.

### Features

#### 1. Contact reliability

Concentration of the contact's normal forces at the single point assures good contact wipe and electrical reliability, while confirming the fully mated condition with a definite tactile click.

#### 2. Self alignment

Recognizing the difficulties of mating extremely small connectors in limited spaces the connectors will self align in horizontal axis within 0.3 mm.

#### 3. Automatic board placement

Packaged on tape-and-reel the plug and headers have sufficiently large flat areas to allow pick-up with vacuum nozzles of automatic placement equipment.

#### 4. Variety of contact positions and styles

Available in standard contact positions of: 20, 22, 24, 30, 34, 40, 50, 60, 70 and 80 with and without metal fittings. Addition of metal fittings does not affect external dimensions of the connectors.

Smaller contact positions are also available.

#### 5. Support for continuity test connector

Connectors which have increased insertion and removal durability are available for continuity tests. Contact your Hirose sales representative for details.

### Applications

Cellular phones, PDA's, mobile computers, digital cameras, digital video cameras, and other devices demanding high reliability connections in extremely limited spaces.

#### Low profile

#### Increased mated retention

#### High contact reliability



### Self alignment



## Product Specifications

|        |                      |   |  |
|--------|----------------------|---|--|
| Rating | Rated current 0.3A   | Operating temperature range : -35°C to 85°C (Note 1)    | Storage temperature range -10°C to 60°C (Note 2)             |
|        | Rated voltage 30V AC | Operating humidity range : Relative humidity 20% to 80% | Storage humidity range Relative humidity 40% to 70% (Note 2) |

| Item                                      | Specification  | Conditions   |
|---|--|--|
| 1. Insulation resistance                  | 50 MΩ min.   | 100V DC  |
| 2. Withstanding voltage                   | No flashover or insulation breakdown.                                | 100V AC / one minute   |
| 3. Contact resistance                     | 100 mΩ max.  | 100 mA   |
| 4. Vibration                              | No electrical discontinuity of 1 μs or more                          | Frequency: 10 to 55 Hz, single amplitude of 0.75mm, 2 hours, 3 axis                                |
| 5. Humidity                               | Contact resistance: 100 mΩ max.<br>Insulation resistance: 25 MΩ min. | 96 hours at temperature of 40°C±2°C and RH of 90% to 95%   |
| 6. Temperature cycle                      | Contact resistance: 100 mΩ max.<br>Insulation resistance: 50 MΩ min. | Temperature: -55°C→+5°C to +35°C→+85°C→+5°C to +35°C<br>Duration: 30→10→30→10(Minutes)<br>5 cycles |
| 7. Durability<br>(insertions/withdrawals) | Contact resistance: 100 mΩ max.                                      | 50 cycles(Connector for conductivity tests: 500 cycles)  |
| 8. Resistance to soldering heat           | No deformation of components affecting performance.                  | Reflow: At the recommended temperature profile<br>Manual soldering: 300°C for 3 seconds            |

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating temperature range and humidity range covers non-conducting condition of installed connectors in storage, shipment or during transportation.

## Materials and Finishes

| Connectors              | Component      | Material        | Finish            | Remarks |
|-------------------------|----------------|-----------------|-------------------|---------|
| Receptacles and Headers | Insulator      | LCP             | Color : Black     | UL94V-0 |
|                         | Contacts       | Phosphor bronze | Gold plated       | ————    |
|                         | Metal fittings | Phosphor bronze | Tin-copper plated | ————    |

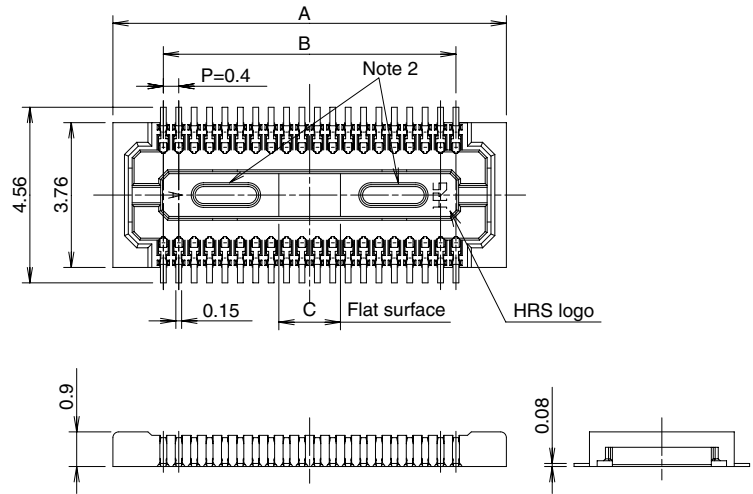
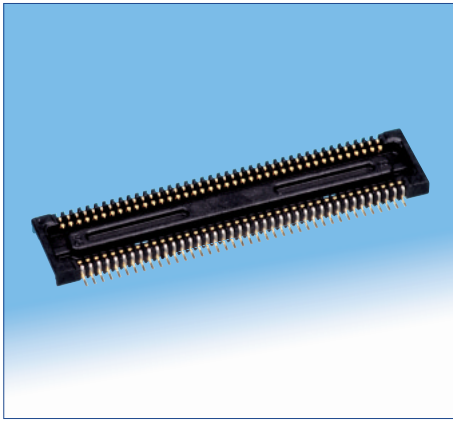
## Ordering information

### Receptacles and Headers

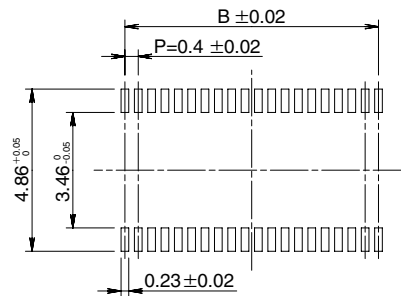
**DF30**   **FC** -   **\***   **DS - 0.4**   **V**   **(\*\*)**  
 ①   ②   ③   ④   ⑤   ⑥   ⑦

|  |   |
|--|---|
| ① Series name: DF30  | ⑤ Contact pitch: 0.4 mm   |
| ② Configuration<br>FB: With metal fittings, without bosses<br>FC: Without metal fittings, without bosses<br>CJ: Connector for conductivity tests | ⑥ Termination section<br>V: Straight SMT  |
| ③ Number of positions: 20, 22, 24, 30, 34, 40, 50, 60, 70, 80  | ⑦ Packaging<br>(81): Embossed tape packaging (5,000 pieces per reel)<br>(82): Embossed tape packaging (1,000 pieces per reel) |
| ④ Connector type<br>DS: Double row receptacle<br>DP: Double row header   |   |

## ■ Receptacles (without metal fittings)



## ◆ Recommended PCB mounting pattern



Recommended solder paste thickness: 120  $\mu$ m

[Specification number] -\*\*, (\*\*)  
(81): Embossed tape packaging (5,000 pieces per reel)

\* Tolerances non- accumulative.

Unit: mm

| Part Number          | CL No.          | Number of contacts | A     | B    | C    |
|----------------------|-----------------|--------------------|-------|------|------|
| DF30FC-20DS-0.4V(**) | CL684-1109-8-** | 20                 | 6.22  | 3.6  | 1.2  |
| DF30FC-22DS-0.4V(**) | CL684-1110-7-** | 22                 | 6.62  | 4.0  | 1.2  |
| DF30FC-24DS-0.4V(**) | CL684-1111-0-** | 24                 | 7.02  | 4.4  | 1.2  |
| DF30FC-30DS-0.4V(**) | CL684-1112-2-** | 30                 | 8.22  | 5.6  | 1.2  |
| DF30FC-34DS-0.4V(**) | CL684-1113-5-** | 34                 | 9.02  | 6.4  | 1.36 |
| DF30FC-40DS-0.4V(**) | CL684-1078-6-** | 40                 | 10.22 | 7.6  | 1.6  |
| DF30FC-50DS-0.4V(**) | CL684-1114-8-** | 50                 | 12.22 | 9.6  | 2.0  |
| DF30FC-60DS-0.4V(**) | CL684-1082-3-** | 60                 | 14.22 | 11.6 | 2.4  |
| DF30FC-70DS-0.4V(**) | CL684-1115-0-** | 70                 | 16.22 | 13.6 | 2.8  |
| DF30FC-80DS-0.4V(**) | CL684-1116-3-** | 80                 | 18.22 | 15.6 | 3.2  |

Note 1: Order by number of reels.

Note 2: Receptacles with 24 or fewer contacts positions will not have recessed areas.



# YDS CAMERA MODULE

*your best camera partner*

## Camera Module Pinout Definition Reference Chart

| OmniVision                    | Sony | Samsung   | On-Semi | Aptina | Himax | GalaxyCore | PixArt | SmartSens | Sensors |
|-------------------------------|------|---|---------|--------|-------|------------|--------|-----------|---------|
| Pin Signal                    |      | Description   |         |        |       |            |        |           |         |
| DGND GND                      |      | ground for digital circuit                              |         |        |       |            |        |           |         |
| AGND                          |      | ground for analog circuit                               |         |        |       |            |        |           |         |
| PCLK DCK                      |      | DVP PCLK output   |         |        |       |            |        |           |         |
| XCLR PWDN XSHUTDOWN STANDBY   |      | power down active high with internal pull-down resistor |         |        |       |            |        |           |         |
| MCLK XVCLK XCLK INCK          |      | system input clock                                      |         |        |       |            |        |           |         |
| RESET RST                     |      | reset active low with internal pull-up resistor         |         |        |       |            |        |           |         |
| NC NULL                       |      | no connect  |         |        |       |            |        |           |         |
| SDA SIO_D SIOD                |      | SCCB data   |         |        |       |            |        |           |         |
| SCL SIO_C SIOC                |      | SCCB input clock  |         |        |       |            |        |           |         |
| VSYNC XVS FSYNC               |      | DVP VSYNC output  |         |        |       |            |        |           |         |
| HREF XHS                      |      | DVP HREF output   |         |        |       |            |        |           |         |
| DOVDD                         |      | power for I/O circuit                                   |         |        |       |            |        |           |         |
| AFVDD                         |      | power for VCM circuit                                   |         |        |       |            |        |           |         |
| AVDD                          |      | power for analog circuit                                |         |        |       |            |        |           |         |
| DVDD                          |      | power for digital circuit                               |         |        |       |            |        |           |         |
| STROBE FSTROBE                |      | strobe output   |         |        |       |            |        |           |         |
| FSIN                          |      | synchronize the VSYNC signal from the other sensor      |         |        |       |            |        |           |         |
| SID                           |      | SCCB last bit ID input                                  |         |        |       |            |        |           |         |
| ILPWM                         |      | mechanical shutter output indicator                     |         |        |       |            |        |           |         |
| FREQ                          |      | frame exposure / mechanical shutter                     |         |        |       |            |        |           |         |
| GPIO                          |      | general purpose inputs                                  |         |        |       |            |        |           |         |
| SLASEL                        |      | I2C slave address select                                |         |        |       |            |        |           |         |
| AFEN                          |      | CEN chip enable active high on VCM driver IC            |         |        |       |            |        |           |         |
| <b>MIPI Interface</b>         |      |   |         |        |       |            |        |           |         |
| MDN0 DN0 MD0N DATA_N DMO1N    |      | MIPI 1st data lane negative output                      |         |        |       |            |        |           |         |
| MDP0 DP0 MD0P DATA_P DMO1P    |      | MIPI 1st data lane positive output                      |         |        |       |            |        |           |         |
| MDN1 DN1 MD1N DATA2_N DMO2N   |      | MIPI 2nd data lane negative output                      |         |        |       |            |        |           |         |
| MDP1 DP1 MD1P DATA2_P DMO2P   |      | MIPI 2nd data lane positive output                      |         |        |       |            |        |           |         |
| MDN2 DN2 MD2N DATA3_N DMO3N   |      | MIPI 3rd data lane negative output                      |         |        |       |            |        |           |         |
| MDP2 DP2 MD2P DATA3_P DMO3P   |      | MIPI 3rd data lane positive output                      |         |        |       |            |        |           |         |
| MDN3 DN3 MD3N DATA4_N DMO4N   |      | MIPI 4th data lane negative output                      |         |        |       |            |        |           |         |
| MDP3 DP3 MD3P DATA4_P DMO4P   |      | MIPI 4th data lane positive output                      |         |        |       |            |        |           |         |
| MCN CLKN CLK_N DCKN           |      | MIPI clock negative output                              |         |        |       |            |        |           |         |
| MCP CLKP MCP CLK_P DCKN       |      | MIPI clock positive output                              |         |        |       |            |        |           |         |
| <b>DVP Parallel Interface</b> |      |   |         |        |       |            |        |           |         |
| D0 DO0 Y0                     |      | DVP data output port 0                                  |         |        |       |            |        |           |         |
| D1 DO1 Y1                     |      | DVP data output port 1                                  |         |        |       |            |        |           |         |
| D2 DO2 Y2                     |      | DVP data output port 2                                  |         |        |       |            |        |           |         |
| D3 DO3 Y3                     |      | DVP data output port 3                                  |         |        |       |            |        |           |         |
| D4 DO4 Y4                     |      | DVP data output port 4                                  |         |        |       |            |        |           |         |
| D5 DO5 Y5                     |      | DVP data output port 5                                  |         |        |       |            |        |           |         |
| D6 DO6 Y6                     |      | DVP data output port 6                                  |         |        |       |            |        |           |         |
| D7 DO7 Y7                     |      | DVP data output port 7                                  |         |        |       |            |        |           |         |
| D8 DO8 Y8                     |      | DVP data output port 8                                  |         |        |       |            |        |           |         |
| D9 DO9 Y9                     |      | DVP data output port 9                                  |         |        |       |            |        |           |         |
| D10 DO10 Y10                  |      | DVP data output port 10                                 |         |        |       |            |        |           |         |
| D11 DO11 Y11                  |      | DVP data output port 11                                 |         |        |       |            |        |           |         |

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## Cameras Applications



### IMAGING DEVICES



## Camera Reliability Test

| Reliability Inspection Item |                             | Testing Method  | Acceptance Criteria     |                         |
|-----------------------------|-----------------------------|---|-------------------------|-------------------------|
| Category                    | Item                        |   |                         |                         |
| Environmental               | Storage Temperature         | High 60°C 96 Hours  | Temperature Chamber     | No Abnormal Situation   |
|                             |                             | Low -20°C 96 Hours  | Temperature Chamber     | No Abnormal Situation   |
|                             | Operation Temperature       | High 60°C 24 Hours  | Temperature Chamber     | No Abnormal Situation   |
|                             |                             | Low -20°C 24 Hours  | Temperature Chamber     | No Abnormal Situation   |
|                             | Humidity                    | 60°C 80% 24 Hours   | Temperature Chamber     | No Abnormal Situation   |
|                             | Thermal Shock               | High 60°C 0.5 Hours<br>Low -20°C 0.5 Hours<br>Cycling in 24 Hours | Temperature Chamber     | No Abnormal Situation   |
| Physical                    | Drop Test (Free Falling)    | Without Package 60cm  | 10 Times on Wood Floor  | Electrically Functional |
|                             |                             | With Package 60cm   | 10 Times on Wood Floor  | Electrically Functional |
|                             | Vibration Test              | 50Hz X-Axis 2mm 30min   | Vibration Table         | Electrically Functional |
|                             |                             | 50Hz Y-Axis 2mm 30min   | Vibration Table         | Electrically Functional |
|                             |                             | 50Hz Z-Axis 2mm 30min   | Vibration Table         | Electrically Functional |
|                             | Cable Tensile Strength Test | Loading Weight 4 kg<br>60 Seconds<br>Cycling in 24 Hours          | Tensile Testing Machine | Electrically Functional |
| Electrical                  | ESD Test                    | Contact Discharge 2 KV  | ESD Testing Machine     | Electrically Functional |
|                             |                             | Air Discharge 4 KV  | ESD Testing Machine     | Electrically Functional |
|                             | Aging Test                  | On/Off 30 Seconds<br>Cycling in 24 Hours                          | Power Switch            | Electrically Functional |
|                             | USB Connector               | On/Off 250 Times  | Plug and Unplug         | Electrically Functional |



## Camera Inspection Standard

| Inspection Item  |          | Inspection Method | Standard of Inspection      |  |                                 |
|------------------|----------|-------------------|-----------------------------|--|---------------------------------|
| Category         | Item     |                   |                             |  |                                 |
| Appearance       | FPC/ PCB | Color             | The Naked Eye               | Major Difference is Not Allowed.           |                                 |
|                  |          | Be Torn/Chopped   | The Naked Eye               | Copper Crack Exposure is Not Allowed.      |                                 |
|                  |          | Marking           | The Naked Eye               | Clear, Recognizable (Within 30cm Distance) |                                 |
|                  | Holder   | Scratches         | The Naked Eye               | The Inside Crack Exposure is Not Allowed   |                                 |
|                  |          | Gap               | The Naked Eye               | Meet the Height Standard                   |                                 |
|                  |          | Screw             | The Naked Eye               | Make Sure Screws Are Presented (If Any)    |                                 |
|                  |          | Damage            | The Naked Eye               | The Inside Crack Exposure is Not Allowed   |                                 |
|                  | Lens     | Scratch           | The Naked Eye               | No Effect On Resolution Standard           |                                 |
|                  |          | Contamination     | The Naked Eye               | No Effect On Resolution Standard           |                                 |
|                  |          | Oil Film          | The Naked Eye               | No Effect On Resolution Standard           |                                 |
|                  |          | Cover Tape        | The Naked Eye               | No Issue On Appearance.                    |                                 |
|                  | Function | Image             | No Communication            | Test Board                                 | Not Allowed                     |
|                  |          |                   | Bright Pixel                | Black Board                                | Not Allowed In the Image Center |
| Dark Pixel       |          |                   | White board                 | Not Allowed In the Image Center            |                                 |
| Blurry           |          |                   | The Naked Eye               | Not Allowed                                |                                 |
| No Image         |          |                   | The Naked Eye               | Not Allowed                                |                                 |
| Vertical Line    |          |                   | The Naked Eye               | Not Allowed                                |                                 |
| Horizontal Line  |          |                   | The Naked Eye               | Not Allowed                                |                                 |
| Light Leakage    |          |                   | The Naked Eye               | Not Allowed                                |                                 |
| Blinking Image   |          |                   | The Naked Eye               | Not Allowed                                |                                 |
| Bruise           |          |                   | Inspection Jig              | Not Allowed                                |                                 |
| Resolution       |          |                   | Chart                       | Follows Outgoing Inspection Chart Standard |                                 |
| Color            |          |                   | The Naked Eye               | No Issue                                   |                                 |
| Noise            |          |                   | The Naked Eye               | Not Allowed                                |                                 |
| Corner Dark      |          |                   | The Naked Eye               | Less Than 100px By 100px                   |                                 |
| Color Resolution |          |                   | The Naked Eye               | No Issue                                   |                                 |
| Dimension        | Height   | The Naked Eye     | Follows Approval Data Sheet |  |                                 |
|                  | Width    | The Naked Eye     | Follows Approval Data Sheet |  |                                 |
|                  | Length   | The Naked Eye     | Follows Approval Data Sheet |  |                                 |
|                  | Overall  | The Naked Eye     | Follows Approval Data Sheet |  |                                 |

## YDSCAM Package Solutions

YDS Camera Module



Complete with Lens Protection Film



Tray with Grid and Space



Place Cameras on the Tray





## YDSCAM Package Solutions

Full Tray of Cameras



Cover Tray with Lid



Place Tray into Anti-Static Bag



Vacuum the Anti-Static Bag



## YDSCAM Package Solutions

### Sealed Vacuum Anti-Static Bag with Labels

1. Model and Description 2. Quantity 3. Manufacturing Date Code 4. Caution



## YDSCAM Package Solutions

Place Foam Sheets Between Tray Bags



Foam Sheets are Larger Than Trays



Place Foam Sheets and Trays into Box



Foam Sheets are Tightly Fitting in Box



Seal the Carbon Box



Label the Carbon Shipping Box

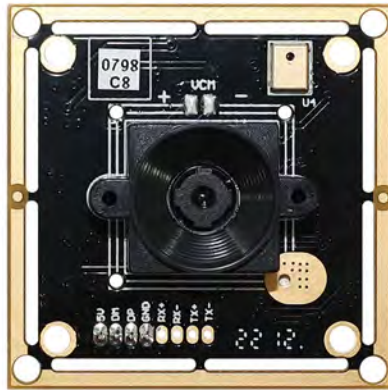




## YDSCAM Package Solutions

USB Camera Module

Complete with Lens Protection Film



Place Camera Sample into Anti-Static Bag

Place USB Cameras into Tray



Seal the Tray with Anti-Static Bag

Label the Carbon Shipping Box



## YDSCAM Package Solutions

Place Camera Sample into Anti-Static Bag



Place Connectors into Anti-Static Bag



Label the Sample Bags



Place Connectors into Reel



Place Samples into the Carbon Box



Place Connectors into the Carbon Box





# YDS CAMERA MODULE

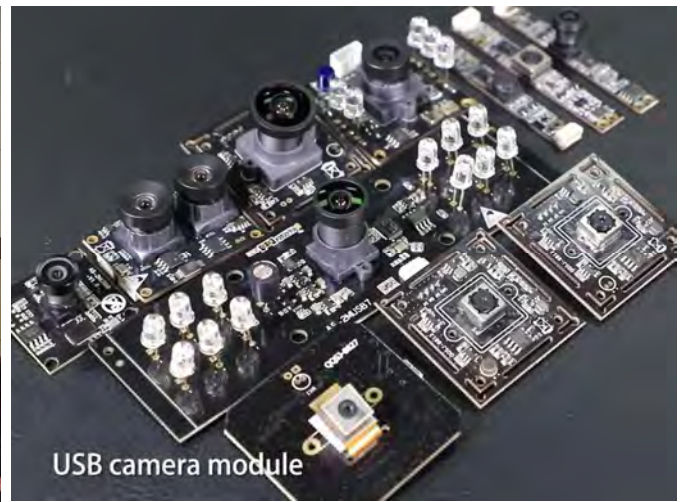
*your best camera partner*

## Company YDSCAM

YingDeShun Co. Ltd. (YDS) was established in 2017, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. YDS is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

YDS provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. YDS specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



## Limited Warranty

YDS provides the following limited warranty if you purchased the Product(s) directly from YDS company or from YDS's website [www.YDSCAM.com](http://www.YDSCAM.com). Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. YDS guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, YDS will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of YDS is solely limited to repair and/or replacement on the terms set forth above. YDS is not reliable or responsible for any subsequent events.



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# YDS CAMERA MODULE

*your best camera partner*

## YDS Strength

### Powerful Factory



### Professional Service



### Promised Delivery



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